



30-PLS16018-12 Information

Heisener.com

30-PLS16018-12 Part Number Manufacturer Aries Electronics

Category Connectors, Interconnects

Sockets for ICs, Transistors

Description CONN SOCKET PGA ZIF GOLD

Package

For the pricing/inventory/lead time, please contact

Website: https://www.heisener.com For Reference Only

E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









30-PLS16018-12 Specifications

Manufacturer Part Number	30-PLS16018-12
Manufacturer	Aries Electronics
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	PLS
Type	PGA, ZIF (ZIP)
Number of Positions or Pins (Grid)	-
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	30μin (0.76μm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Closed Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	200μin (5.08μm)
Contact Material - Post	Beryllium Copper
Housing Material	Polyphenylene Sulfide (PPS)
Operating Temperature	-65°C ~ 125°C
	Report errors?

30-PLS16018-12 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

30-PLS16018-12 Payment Methods



















30-PLS16018-12 Shipping Methods













If you have any question about 30-PLS16018-12, please do not hesitate to contact us!

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